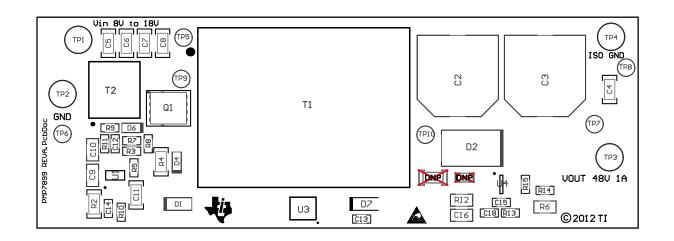
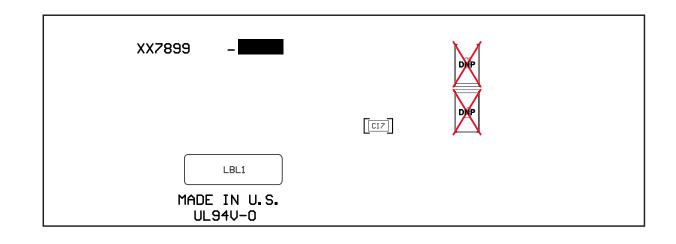
- ZZ1 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1
- ZZZ ■These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



| TABLE 1 | | | | |
|---------|------------------|--|--|--|
| Variant | riant Label text | | | |
| 001 | ChangeMe! | | | |
| 002 | ChangeMe! | | | |

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE | BOARD #: XX7899 | REV: E1 | SUN REU: | : Not In VersionControl |
|----------------------------------|--------------------|--------------|----------|-------------------------|
| IGNORE -> Top Overlay | | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 12/19/ | 2012 4:11:40 | PM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS ASSEMBLY VARIANT: 001

| PCB VIEWED FROM BOTTOM SIDE | BOARD #: XX7899 | REV: E1 | SUN REV: | Not In VersionControl |
|-------------------------------------|---------------------------|--------------|-----------|-----------------------|
| | Bottom Overlay <- Januari | | Bottom Ov | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 12/19/ | 2012 4:11:41 | PM | TEXAS INSTRUMENTS |

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